

In-Line Multiport Calibration Algorithm

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Abstract- We present a multiport measurement algorithm that uses only conventional in-line calibrations. The algorithm is well suited to performing on-wafer multiport measurements, and can correct with the thru-reflect-line calibration. We demonstrate the algorithm in a four-port measurement system.

INTRODUCTION

We present a multiport calibration procedure based on conventional in-line two-port calibrations. This procedure allows on-wafer multiport measurements to be corrected by standard two-port calibrations, including the multiline thru-reflect-line (TRL) calibration [1]. It also reduces to an absolute minimum the number of connections made to the standards, requires only a set of six additional self-terminating switches to implement in a conventional wafer probing system, and fully corrects for imperfect termination impedances at all the measurement ports.

The algorithm is similar to those proposed by [2] and [3], and is not limited to open-short-thru-load (OSLT) calibrations, as are the algorithms of [4] and [5]. In its current implementation, the algorithm can be used to perform four-port, three-port, and orthogonal two-port measurements, although extension to more than four ports is straight forward.

MULTIPOINT CALIBRATION

The calibration corrects measurements made by the on-wafer probing system of Fig. 1, which consists of a conventional two-port network analyzer and six coaxial switches routing signals from port 1 of the analyzer to what we label the north, south, and west probes, and from port 2 of the analyzer to the north, south, and east probes. The system is arranged so that, when it is not

being used to connect the device under test to the analyzer, a unique termination impedance is applied to the unused probes.

We begin the calibration and measurement procedure by connecting two-port in-line calibration standards between the west and east probes. We used this calibration to correct all the raw data taken by the analyzer to on-wafer measurement reference planes at the west and east ports. During the measurements of the thru line, we use the switches to disconnect first the west probe, and then the east probe, from the analyzer, and measure their imperfect on-wafer termination impedances.

In the second step of the procedure, we connect the two-port calibration standards between the north and south ports. We used measurements taken in this configuration to determine four “error boxes” from a two-tier calibration procedure. These error boxes map measurements corrected to the west and east on-wafer reference planes to measurements corrected at the north and south on-wafer reference planes: they are uniquely

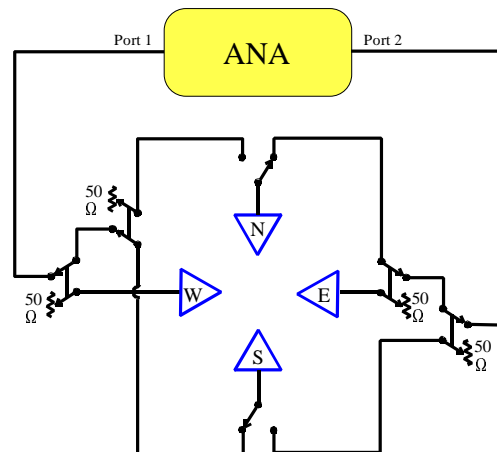


Fig. 1. Four port measurement system schematic. Switches shown with port one of the analyzer connected to the south probe and port two connected to the north probe. The east and west probes are each terminated in 50 Ω .

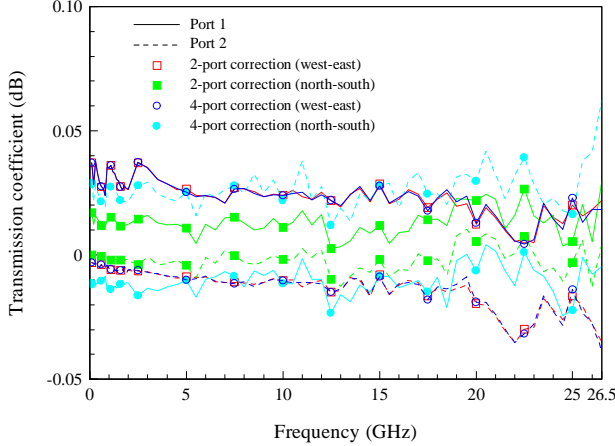


Fig. 2. The transmission coefficients of our thru line measured as a two-port and a four-port. In order to measure the thru line as a four port we lifted the two unused probes off the substrate.

determined because the switching network is passive and reciprocal. Again, during the measurements of the thru line, we also measure the imperfect termination impedances of the north and south probes.

The final step of the procedure fills a four-by-four scattering parameter matrix for each multiport device with two-port measurement values with the procedure of [2]. Before adding these values to the matrix, we transformed the reference impedances of each set of 50Ω two-port measurements to the imperfect termination impedances of the two probes used to make them. This insures that the four-by-four scattering parameter matrix, whose reference impedances are equal to the four imperfect on-wafer termination impedances of the probes, is filled consistently.

To illustrate the procedure, consider how we use a measurement made at the west and north reference planes to fill the corresponding elements of the four-by-four scattering parameter matrix. We first correct the raw two-port west-north measurement to the west and east reference planes. Then we apply an error box to port two of the partially corrected west-east data to transform it to a measurement corrected at the west-north reference planes. Finally, we transform the reference impedances of this corrected 50Ω west-north measurement to the imperfect termination impedances of the west and north probes.

Since all the measurements we add to the matrix have consistent reference impedances, this procedure allows us to fill the four-by-four matrix with the two-

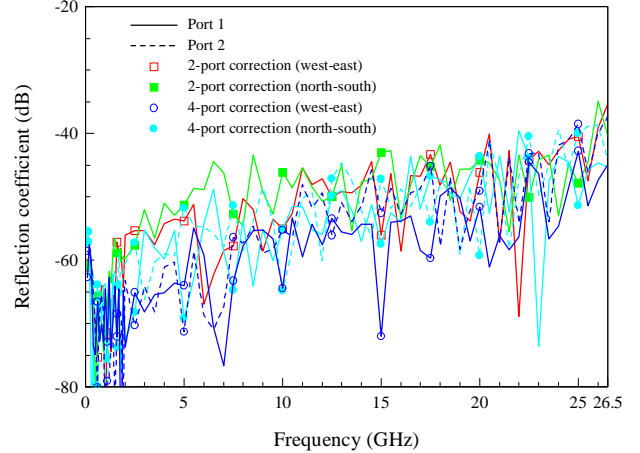


Fig. 3. The reflection coefficients of the thru line of Fig. 2.

port results in a straightforward way. However, the reference impedances of this four-by-four scattering matrix correspond to the imperfect termination impedances of the four probes, not 50Ω .

Once the four-by-four matrix is completely filled, we translate all its reference impedances back to 50Ω using the formulas in Appendix E of [6]. At this point we can assign port numbers to the east, west, north, and south reference planes, and the algorithm forms matrices of four-port, three-port, or two-port scattering and impedance parameters. The algorithm is also designed to construct differential even and odd mode parameters in its four-port correction mode.

MEASUREMENT EXAMPLE

We demonstrated our system with the multilayer TRL algorithm of [1]. The standards consisted of a $550 \mu\text{m}$ long coplanar waveguide (CPW) thru line, five longer lines of length 2.685 mm , 3.75 mm , 7.115 mm , 20.245 mm , and 40.55 mm , and two shorts offset $225 \mu\text{m}$ from the beginning of the line, all fabricated on a semi-insulating gallium arsenide substrate. The CPW had a center conductor width of $64 \mu\text{m}$ separated from two $261.5 \mu\text{m}$ wide ground planes by two $42 \mu\text{m}$ gaps. We moved the reference plane of the calibration to $25 \mu\text{m}$ in front of the physical beginning of the lines and set the reference impedance to 50Ω with the method of [7].

Figures 2 and 3 compare conventional two-port measurements of the thru line we used in the calibration with measurements of the same thru line performed by

our calibrated four-port system. The figures show that the calibration procedure accounts for the imperfect termination impedances and properly corrects the data.

The figures also show that the noise in the four-port measurements is comparable to the noise in the two-port measurements. Although not shown, our experiments indicated that the noise in the measurements can be reduced slightly by using one-tier calibrations to correct, when possible, the data measured at the north and south ports.

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